

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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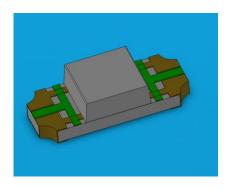






DATASHEET

SMD • B 23-23B/R6GHBHC-A01/2A



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

- The 23-23B SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.



Device Selection Guide

Code	Chip Materials	Emitted Color	Resin Color
R6	AlGaInP	Brilliant Red	
GH	InGaN	Brilliant Green	- Water Clear
ВН	InGaN	Blue	_

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Code	Rating	Unit	
Reverse Voltage	V _R		5	V	
Forward Current	I _F	R6	25		
		GH	20	mA	
		ВН	20	_	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	R6	60		
		GH	75	mA	
		ВН	75	_	
Power Dissipation	Pd	R6	60		
		GH	95	 mW	
		BH	95	_	
Electrostatic Discharge(HBM)	ESD _{HBM}	R6	2000		
		GH	150		
		BH	150	_	
Operating Temperature	T _{opr}		-40 ~ +85	$^{\circ}$	
Storage Temperature	Tstg		-40 ~ +90	$^{\circ}$	
Soldering Temperature	Tsol			dering : 260 $^{\circ}$ C for 10 sec. ering : 350 $^{\circ}$ C for 3 sec.	



Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Code	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	R6	72	100			
		GH	140	200		mcd	
		ВН	45	65			
Viewing Angle	2θ _{1/2}			130		Deg	_
Peak Wavelength	λр	R6		632			I _F =20mA
		GH		518		nm	
		ВН		468			
Dominant Wavelength	λd	R6		624			
		GH		525		nm	
		ВН		470			
Spectrum Radiation Bandwidth	△λ	R6		20			
		GH		35		nm	
		ВН		25			
Forward Voltage	V_{F}	R6	1.7	2.0	2.4		
		GH	2.7	3.3	3.7	V	
		ВН	2.7	3.3	3.7		
Reverse Current	I _R	R6			10		V _R =5V
		GH			50	μA	
		ВН			50		

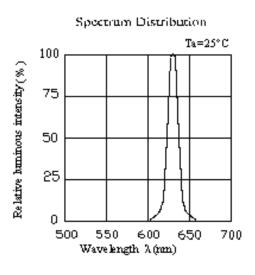
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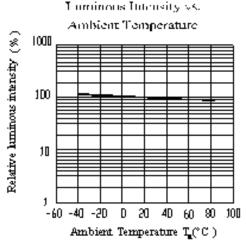
^{1.}Tolerance of Luminous Intensity: ±11%

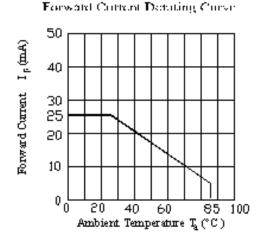


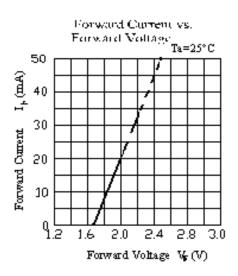
Typical Electro-Optical Characteristics Curves

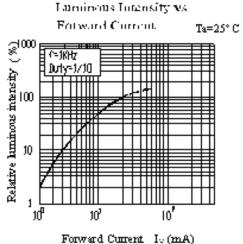
R6

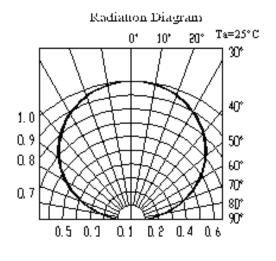








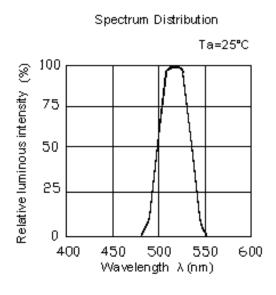


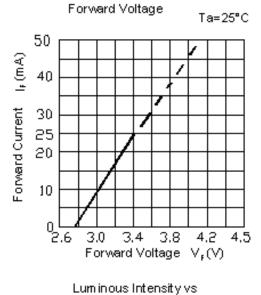




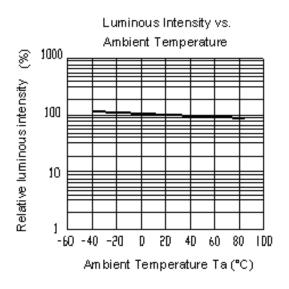
Typical Electro-Optical Characteristics Curves

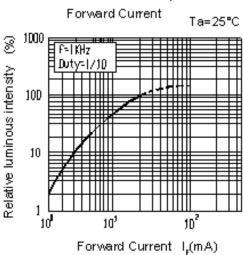
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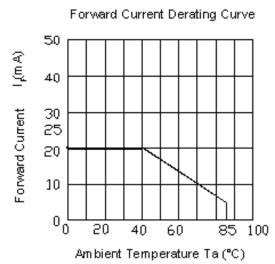


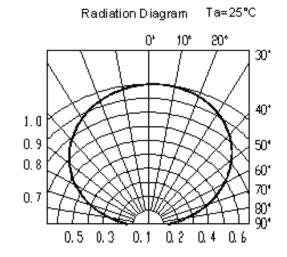


Forward Current vs.



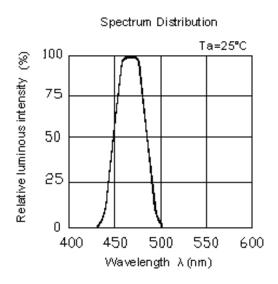


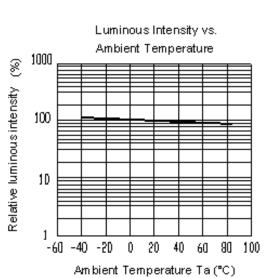


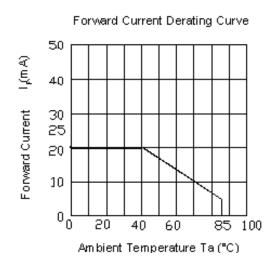


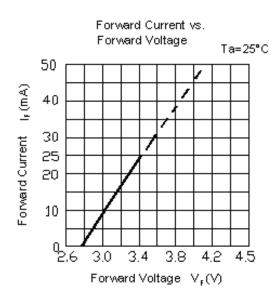
Typical Electro-Optical Characteristics Curves

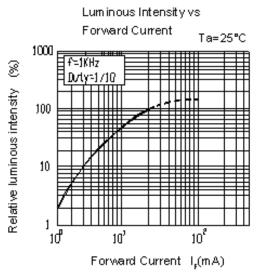
BH

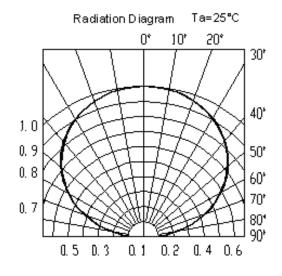






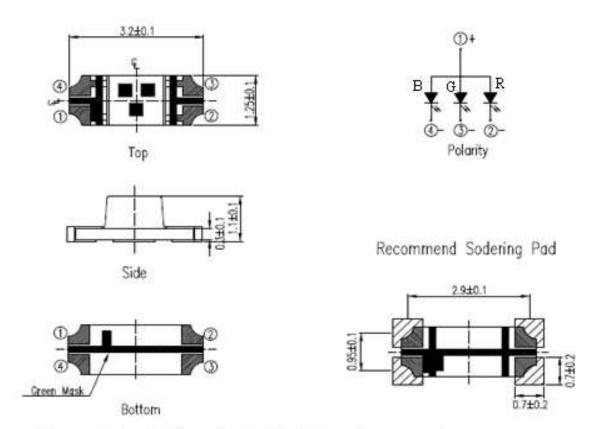








Package Dimension



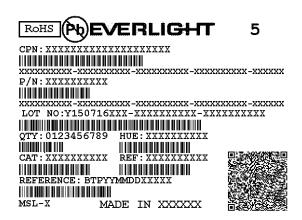
Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm



Moisture Resistant Packing Materials

Label Explanation



· CPN: Customer's Product Number

P/N: Product NumberQTY: Packing Quantity

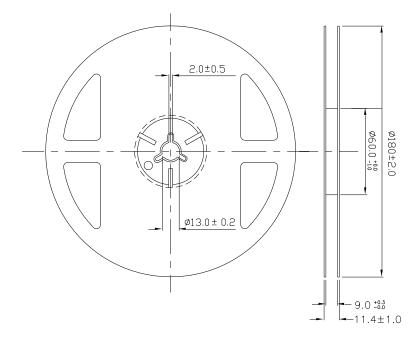
· CAT: Luminous Intensity Rank

· HUE: Chromaticity Coordinates & Dom. Wavelength Rank

· REF: Forward Voltage Rank

· LOT No: Lot Number

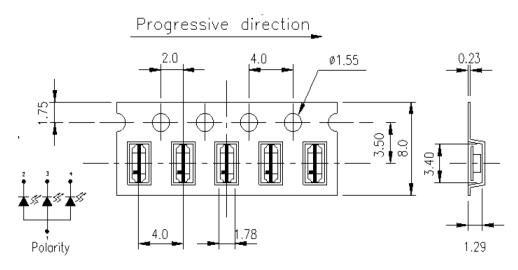
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

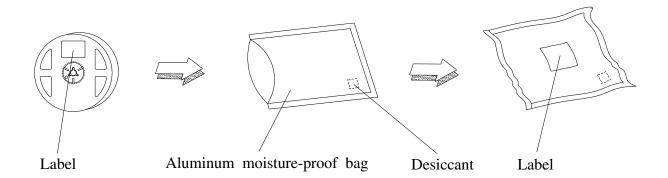


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is $\pm 0.1 \text{mm}$, Unit = mm

Moisture Resistant Packaging





Precautions For Use

1. Over-current-proof

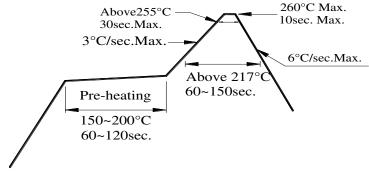
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°℃ or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



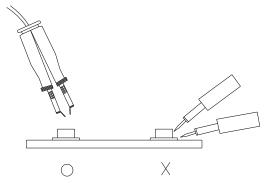
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.



DISCLAIMER

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- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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